



AP1151ADS

14V Input Adjustable Voltage LDO Regulator

1. General Description

The AP1151ADS is a low dropout linear regulator with ON/OFF control, which can supply 200mA load current. The IC is an integrated circuit with a silicon monolithic bipolar structure. The output voltage can be set from 1.3V to 14.5V by external resistors. The output capacitor is available to use a small 0.22μF ceramic capacitor. The over current, thermal and reverse bias protections are integrated, and also the package is small and thin type. The IC is designed for space saving requirements.

2. Features

- Available to use a small 0.22μF ceramic capacitor
- Dropout Voltage $V_{\text{DROP}}=120\text{mV}$ at 100mA
- Output Current 200mA, Peak 320mA
- High Precision reference voltage $1.27\text{V} \pm 20\text{mV}$
- Programmable output voltage 1.3V to 13.5V
- High ripple rejection ratio 80dB at 1kHz
- Wide operating voltage range 2.1V to 14.0V
- Very low quiescent current $I_{\text{QUT}}=78\mu\text{A}$ at $I_{\text{OUT}}=0\text{mA}$
- On/Off control (High active)
- Built-in Short circuit protection, thermal shutdown
- Built-in reverse bias over current protection
- Available very low noise application
- Very small surface mount package SOT23-6

3. Applications

- Automotive accessory equipment
- Any Electronic Equipment
- Battery Powered Systems
- Mobile Communication

4. Table of Contents

1.	General Description	1
2.	Features	1
3.	Applications	1
4.	Table of Contents	2
5.	Block Diagram	3
6.	Ordering Information	3
7.	Pin Configurations and Functions	3
	■ Pin Configurations	3
	■ Function	4
8.	Absolute Maximum Ratings	5
9.	Recommended Operating Conditions	5
10.	Electrical Characteristics	6
	■ Electrical Characteristics of Ta=Tj=25°C	6
	■ Electrical Characteristics of Ta=-40°C~85°C	7
11.	Description	8
	11.1 DC Characteristics	8
	11.2 Temperature Characteristics	12
	11.3 AC Characteristics	14
	11.4 ON / OFF Transient	16
	11.5 LOAD Transient	17
	11.6 Line Transient	18
	11.7 Output Noise Characteristics	19
	11.8 ESR Stability	20
	11.9 Operating Region and Power Dissipation	21
	11.10 ON/OFF Control	22
	11.11 Noise Bypass	22
	11.12 The notes of the evaluation when output terminal is short-circuit to GND	23
12.	Definition of term	24
13.	Recommended External Circuits	25
	■ External Circuit	25
	■ Test Circuit	25
14.	Package	26
	■ Outline Dimensions	26
15.	Revise History	27
	IMPORTANT NOTICE	28

5. Block Diagram

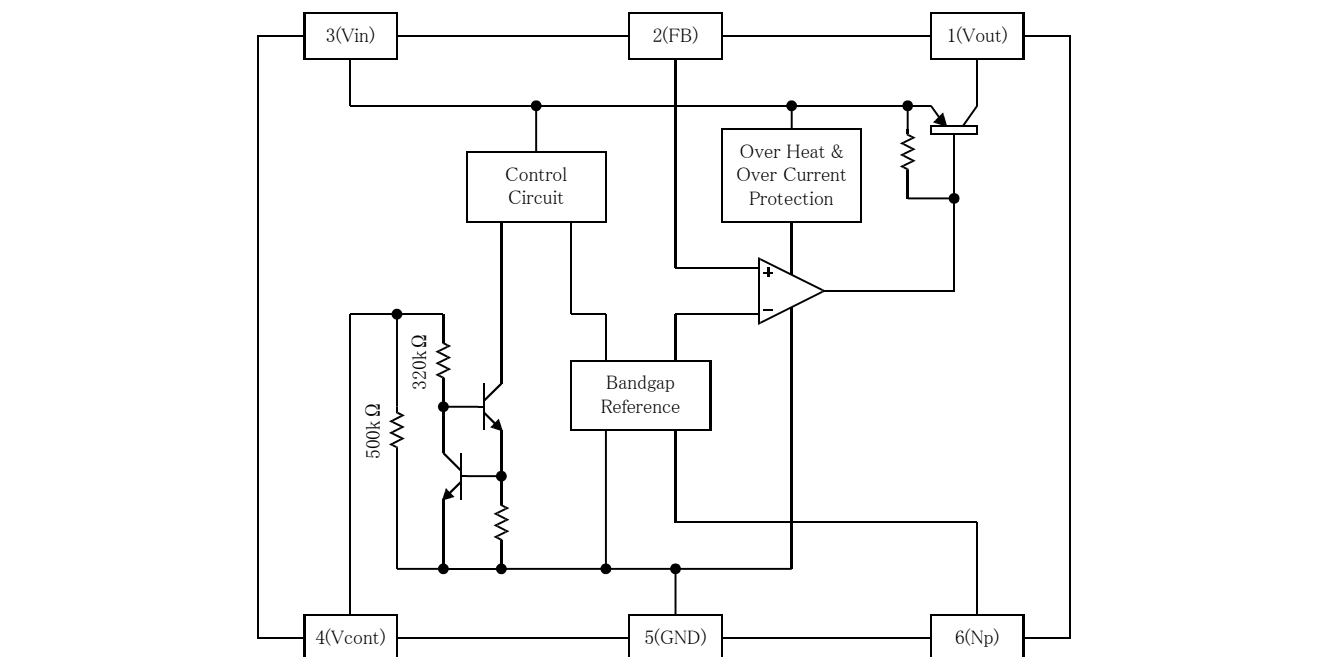


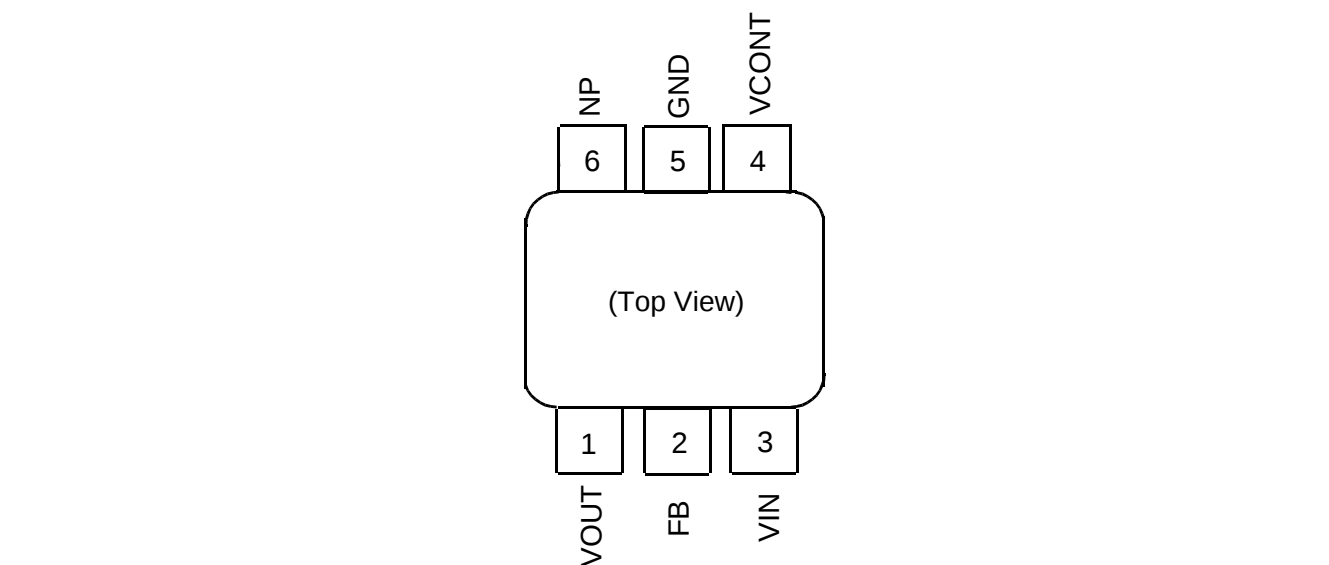
Figure 1. Block Diagram

6. Ordering Information

AP1151ADS Ta = -40 to 85°C SOT23-6

7.Pin Configurations and Functions

■ Pin Configurations



■ Function

Pin No.	Pin Description	Internal Equivalent Circuit	Description
1	VOUT		Output Terminal The output voltage is decided by the following formulas. $VOUT = V_{FB} \times \frac{R1 + R2}{R1}$
2	FB		Feedback Terminal Connect a resistance R1 between GND, and a resistance R2 between Vout.
3	VIN		Input Terminal
4	VCONT		On/Off Control Terminal $V_{CONT} > 1.8V$: ON $V_{CONT} < 0.35V$: OFF The pull-down resistor (500kΩ) is built-in.
5	GND		GND Terminal
6	NP		Noise Bypass Terminal Connect a bypass capacitor between GND.

8. Absolute Maximum Ratings

Parameter	Symbol	min	max	Unit	Condition
Supply Voltage	V_{CCMAX}	-0.4	16	V	
Reverse Bias	V_{revMAX}	-0.4	6	V	$V_{out_{TYP}} \leq 2.0V$
		-0.4	14.5	V	$2.0V < V_{out_{TYP}}$
FB Pin Voltage	V_{fbMAX}	-0.4	5	V	
Np Pin Voltage	$V_{NP_{MAX}}$	-0.4	5	V	
Control Pin Voltage	$V_{CONTMAX}$	-0.4	16	V	
Junction temperature	T_j	-	150	°C	
Storage Temperature Range	T_{STG}	-55	150	°C	
Power Dissipation	P_D	-	500	mW	Mounted on PCB (Note 1)

Note 1. P_D must be decreased at rate of 4.0mW/°C for operation above 25°C. $\theta_{JA} = 250^\circ\text{C}/\text{W}$.

WARNING: The maximum ratings are the absolute limitation values with the possibility of the IC breakage. When the operation exceeds this standard quality cannot be guaranteed.

9. Recommended Operating Conditions

Parameter	Symbol	min	typ	max	Unit	Condition
Operating Temperature Range	T_a	-40	-	85	°C	
Operating Voltage Range	V_{OP}	2.1	-	14	V	
Output Voltage Range	V_{out}	1.3	-	13.5	V	

10. Electrical Characteristics

■ Electrical Characteristics of Ta=Tj=25°C

The parameters with min or max values will be guaranteed at Ta=Tj=25°C.

(Vin=4.0V, R1=51kΩ, R2=68kΩ, Vcont=1.8V, Ta=Tj=25°C, unless otherwise specified.)

Parameter	Symbol	Condition	min	typ	max	Unit
FB pin Voltage	Vfb	Iout = 5mA	1.250	1.270	1.290	V
Line Regulation	LinReg	ΔVin = 5V	-	0.0	5.0	mV
Load Regulation (Note 2)	LoaReg	Iout = 5mA ~ 100mA	-	11	27	mV
		Iout = 5mA ~ 200mA	-	26	61	mV
Dropout Voltage	Vdrop	Iout = 50mA	-	80	140	mV
		Iout = 100mA	-	120	210	mV
		Iout = 200mA	-	200	350	mV
Maximum Output Current (Note 3)	IoutMAX	When Vout drops 0.3V	240	320	-	mA
Quiescent Current	Iq	Iout = 0mA	-	78	125	μA
Standby Current	Istandby	Vcont = 0V	-	0.0	0.1	μA
GND Pin Current	Ignd	Iout = 50mA	-	1.0	1.8	mA
Control Terminal						
Control Current	Icont	Vcont = 1.8V	-	5.0	15.0	μA
Control Voltage	Vcont	Vout ON state	1.8	-	-	V
		Vout OFF state	-	-	0.35	V
Reference Value						
Np Terminal Voltage	Vnp		-	1.27	-	V
Output Voltage / Temp.	Vo/Ta		-	35	-	ppm / °C
Output Noise Voltage	Vno	Cout=1.0μF, Cnp=0.01μF Cfb=100pF, Iout=30mA	-	34	-	μVrms
Ripple Rejection	R.R	Cout=1.0μF, Cnp=0.01μF Cfb=100pF, Iout=10mA, f=1kHz	-	80	-	dB
Rise Time	tr	Cout=1.0μF, Cnp=0.001μF Cfb=100pF Vcont : Pulse Wave (100Hz) Vcont ON → Vout×95% point	-	40	-	μs

Note 2. Load Regulation changes with output voltage. The value mentioned above is guaranteed with the condition at R1=51kΩ, R2=68kΩ (set at Vout_TYP=3.0V).

Note 3. The maximum output current is limited by power dissipation.

■ Electrical Characteristics of Ta=-40°C~85°C

The parameters with min or max values will be guaranteed at Ta=-40 ~ 85°C.

(Vin=4.0V, R1=51kΩ, R2=68kΩ, Vcont=1.8V, Ta= -40 ~ 85°C, unless otherwise specified.)

Parameter	Symbol	Condition	min	typ	max	Unit
FB pin Voltage	Vfb	Iout = 5mA	1.240	1.270	1.300	V
Line Regulation	LinReg	ΔVin = 5V	-	0.0	8.0	mV
Load Regulation (Note 4)	LoaReg	Iout = 5mA ~ 100mA	-	11	50	mV
		Iout = 5mA ~ 200mA	-	26	80	mV
Dropout Voltage	Vdrop	Iout = 50mA	-	80	180	mV
		Iout = 100mA	-	120	270	mV
		Iout = 200mA	-	200	390	mV
Maximum Output Current (Note 5)	IoutMAX	When Vout drops 0.3V	220	320	-	mA
Quiescent Current	Iq	Iout = 0mA	-	78	150	μA
Standby Current	Istandby	Vcont = 0V	-	0.0	0.5	μA
GND Pin Current	Ignd	Iout = 50mA	-	1.0	2.2	mA
Control Terminal						
Control Current	Icont	Vcont = 1.8V	-	5.0	15.0	μA
Control Voltage	Vcont	Vout ON state	1.8	-	-	V
		Vout OFF state	-	-	0.35	V
Reference Value						
Np Terminal Voltage	Vnp		-	1.27	-	V
Output Voltage / Temp.	Vo/Ta		-	35	-	ppm /°C
Output Noise Voltage	Vno	Cout=1.0μF, Cnp=0.01μF Cfb=100pF, Iout=30mA	-	34	-	μVrms
Ripple Rejection	R.R	Cout=1.0μF, Cnp=0.01μF Cfb=100pF, Iout=10mA, f=1kHz	-	80	-	dB
Rise Time	tr	Cout=1.0μF, Cnp=0.001μF Cfb=100pF Vcont : Pulse Wave (100Hz) Vcont ON → Vout×95% point	-	40	-	μs

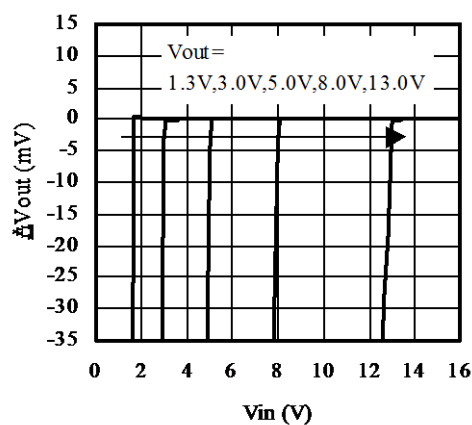
Note 4. Load Regulation changes with output voltage. The value mentioned above is guaranteed with the condition at R1=51kΩ, R2=68kΩ (set at Vout_TYP=3.0V).

Note 5. The maximum output current is limited by power dissipation.

11. Description

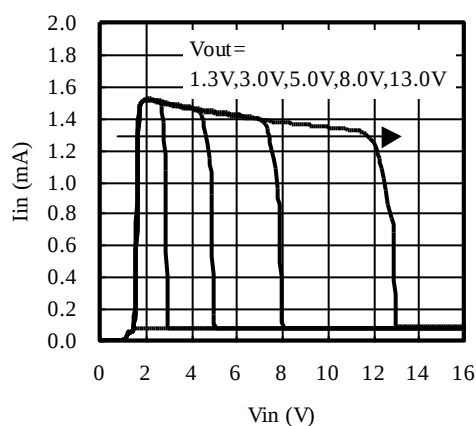
11.1 DC Characteristics

■ Line Regulation



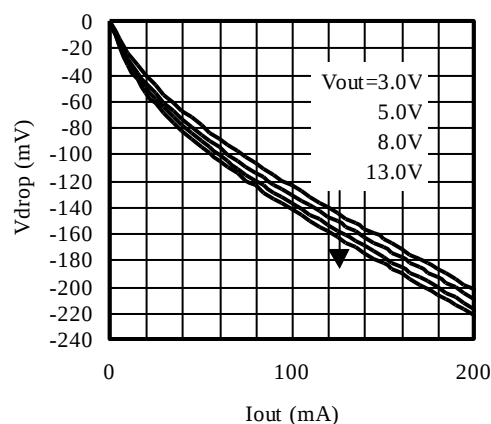
■ I_{in} vs V_{in}

$I_{out}=0\text{mA}$

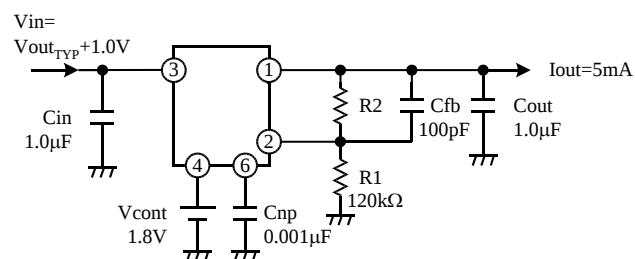


■ Dropout Voltage

$2.1\text{V} \leq V_{out_TYP}$



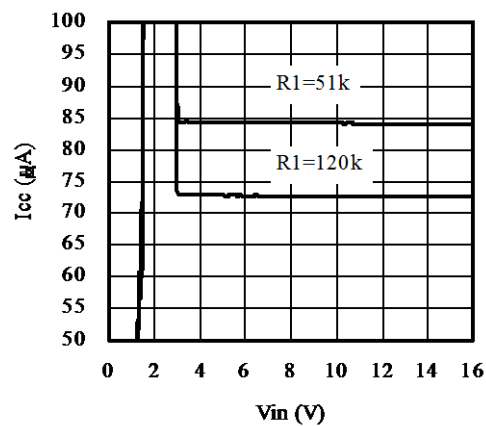
Test conditions



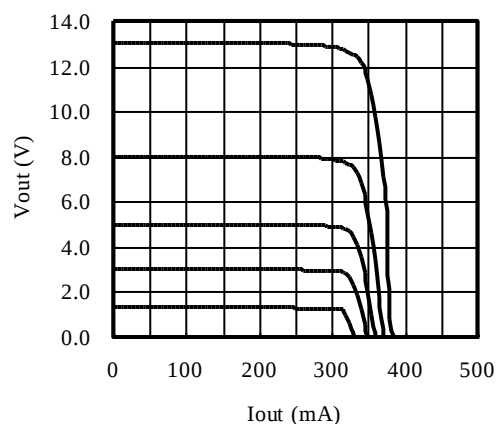
$V_{out_TYP} = 1.3\text{V}$: $R1=120\text{k}\Omega$, $R2=2.8\text{k}\Omega$
 3.0V : $R1=120\text{k}\Omega$, $R2=163.5\text{k}\Omega$
 5.0V : $R1=120\text{k}\Omega$, $R2=352\text{k}\Omega$
 8.0V : $R1=75\text{k}\Omega$, $R2=397\text{k}\Omega$
 13.0V : $R1=51\text{k}\Omega$, $R2=470\text{k}\Omega$

■ Supply Current

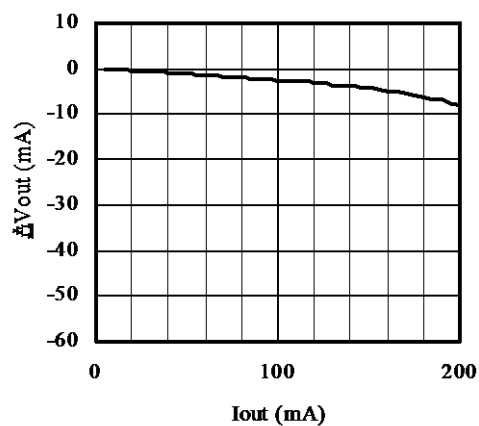
$I_{out}=0\text{mA}$, $V_{out_TYP}=3.0\text{V}$



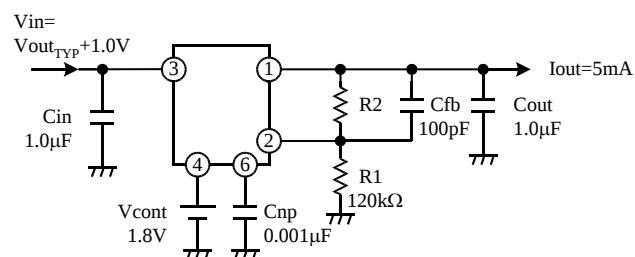
■ Short Circuit Current



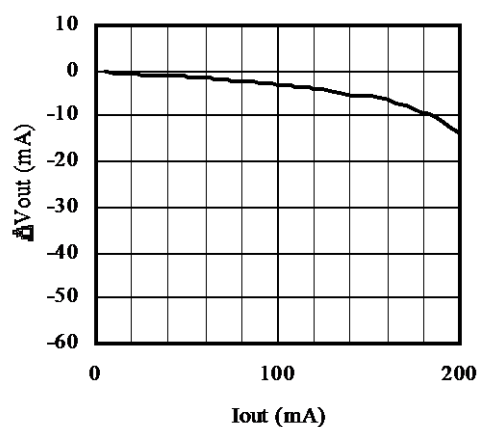
■ Load Regulation

 $V_{out_TYP}=1.3V$ 

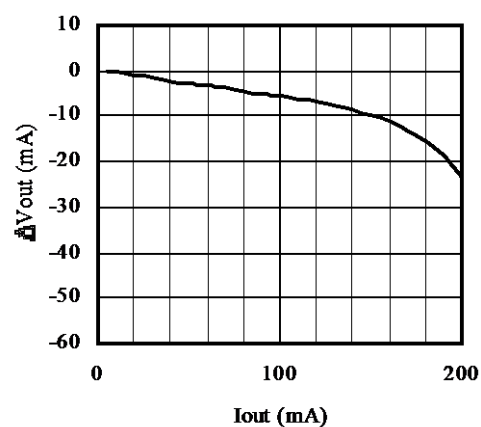
Test conditions

 $V_{out_TYP}=1.3V$: $R1=120k\Omega$, $R2=2.8k\Omega$ 3.0V: $R1=120k\Omega$, $R2=163.5k\Omega$ 5.0V: $R1=120k\Omega$, $R2=352k\Omega$ 8.0V: $R1=75k\Omega$, $R2=397k\Omega$ 13.0V : $R1=51k\Omega$, $R2=470k\Omega$

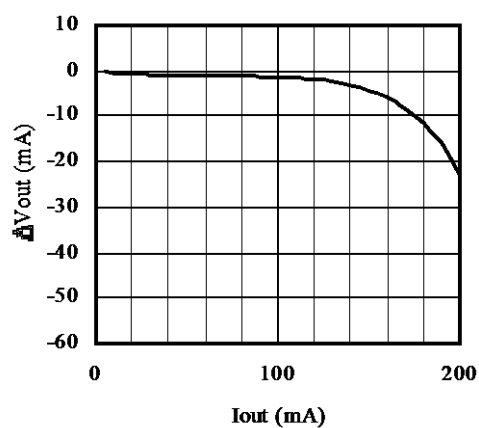
■ Load Regulation

 $V_{out_TYP}=3.0V$ 

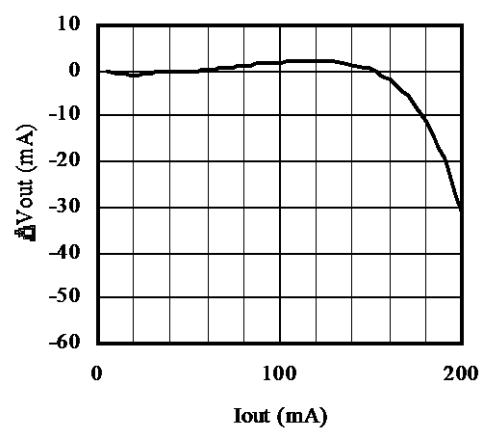
■ Load Regulation

 $V_{out_TYP}=5.0V$ 

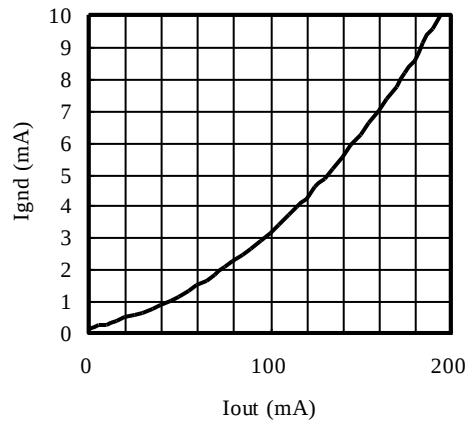
■ Load Regulation

 $V_{out_TYP}=8.0V$ 

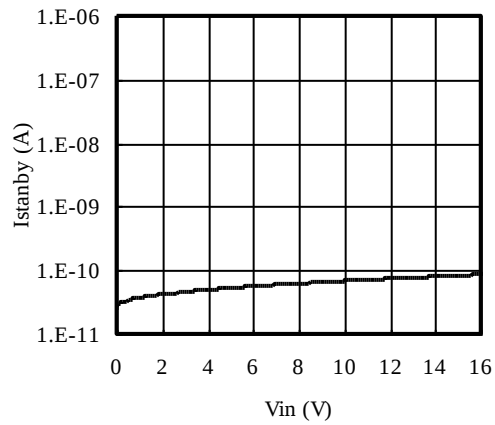
■ Load Regulation

 $V_{out_TYP}=13.0V$ 

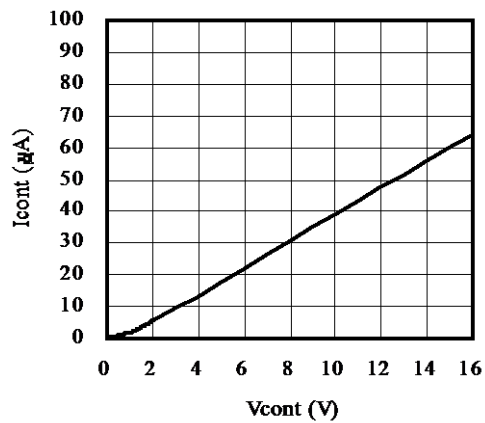
■ Quiescent Current



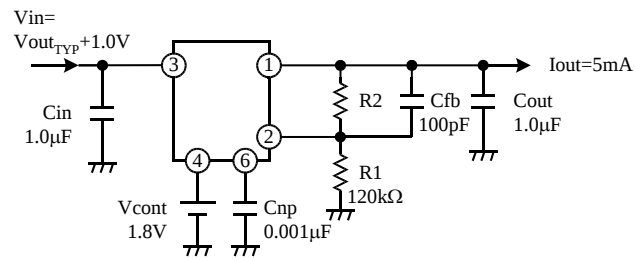
■ Standby Current (Off state)
Vcont=0V



■ Control Current

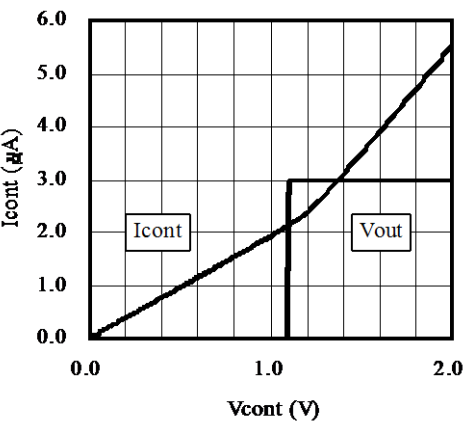


Test conditions



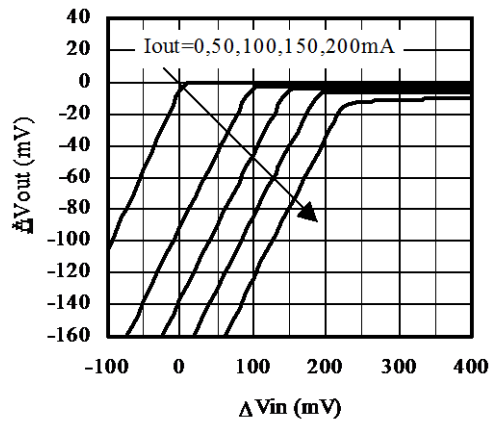
Vout_TYP = 1.3V	: R1=120kΩ, R2=2.8kΩ
3.0V	: R1=120kΩ, R2=163.5kΩ
5.0V	: R1=120kΩ, R2=352kΩ
8.0V	: R1=75kΩ, R2=397kΩ
13.0V	: R1=51kΩ, R2=470kΩ

■ Control Current, ON/OFF Point



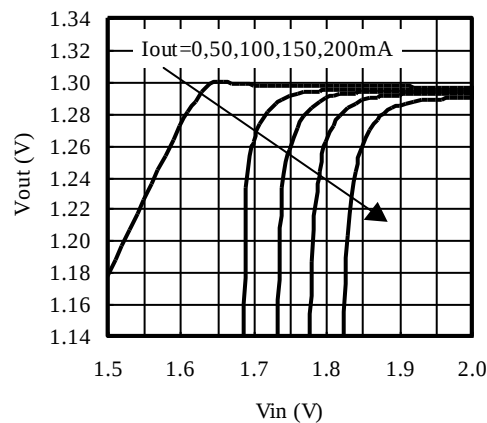
■ Vin vs Vout Regulation Point

$2.1V \leq V_{out_TYP}$

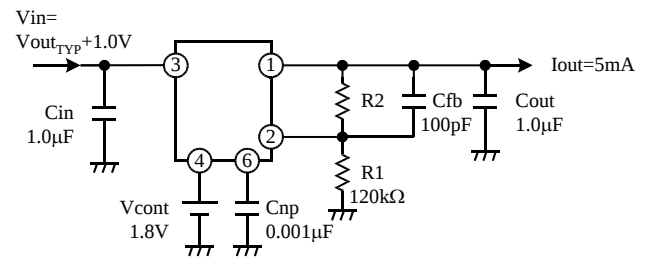


■ Vin vs Vout Regulation Point

$V_{out_TYP}=1.3V$



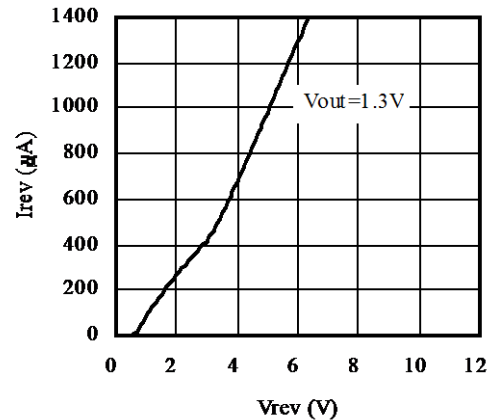
Test conditions



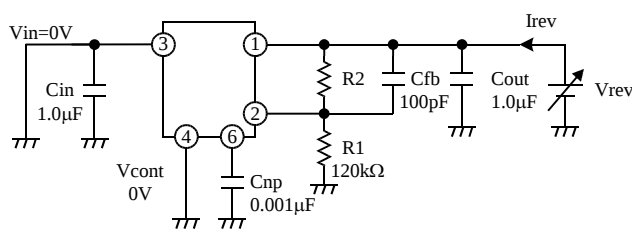
$V_{out_TYP}= 1.3V$: $R1=120k\Omega$, $R2=2.8k\Omega$
 $3.0V$: $R1=120k\Omega$, $R2=163.5k\Omega$
 $5.0V$: $R1=120k\Omega$, $R2=352k\Omega$
 $8.0V$: $R1=75k\Omega$, $R2=397k\Omega$
 $13.0V$: $R1=51k\Omega$, $R2=470k\Omega$

■ Reverse Bias Current

$V_{out_TYP}=1.3V$



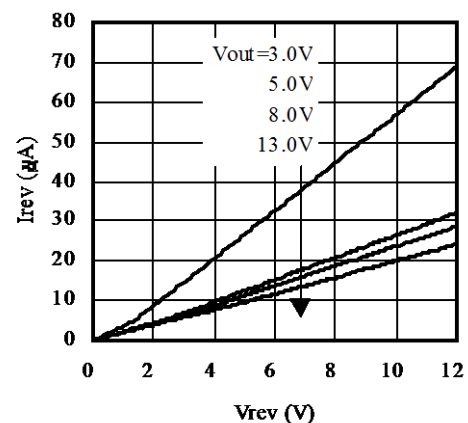
Test conditions (Reverse Bias Current)



$V_{out_TYP}= 1.3V$: $R1=120k\Omega$, $R2=2.8k\Omega$
 $3.0V$: $R1=120k\Omega$, $R2=163.5k\Omega$
 $5.0V$: $R1=120k\Omega$, $R2=352k\Omega$
 $8.0V$: $R1=75k\Omega$, $R2=397k\Omega$
 $13.0V$: $R1=51k\Omega$, $R2=470k\Omega$

■ Reverse Bias Current

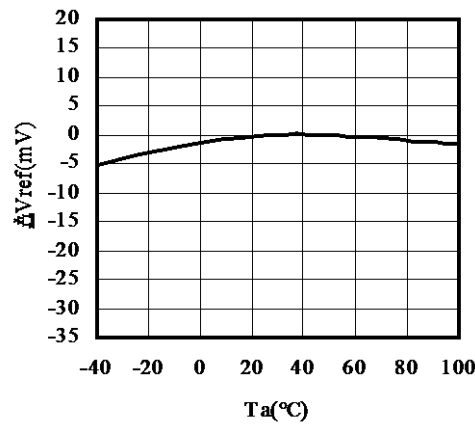
$V_{out_TYP}=3.0V, 5.0V, 8.0V, 13.0V$



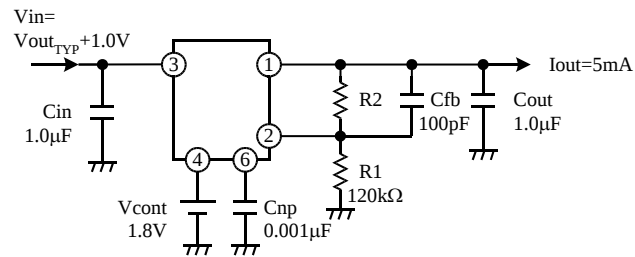
11.2 Temperature Characteristics

■ Vref

Vref_TYP=1.27V



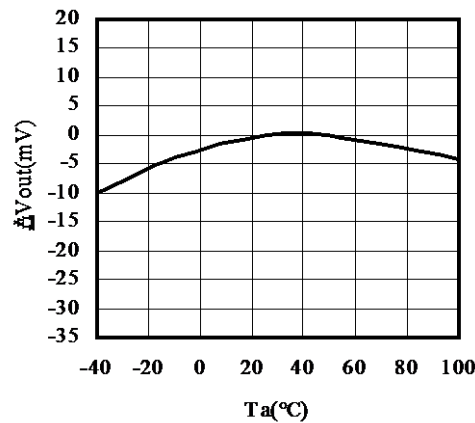
Test conditions



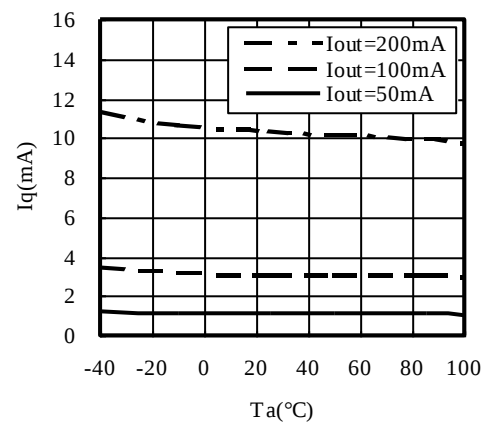
Vout_TYP=3.0V : R2=163.5kΩ

■ Vout

Vout_TYP=3.0V

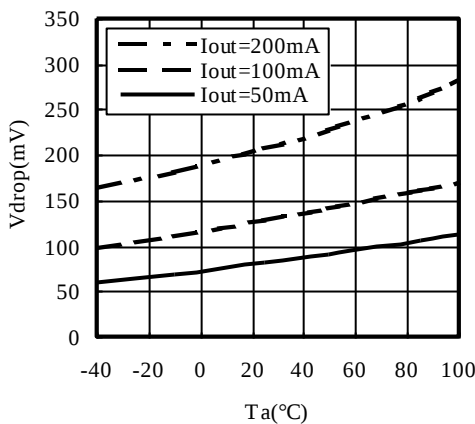


■ Quiescent Current



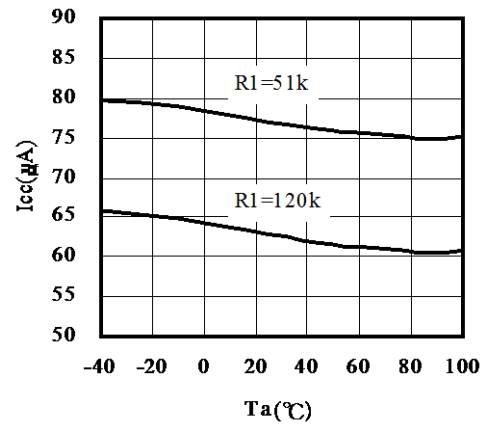
■ Dropout Voltage

2.1V ≤ Vout_TYP



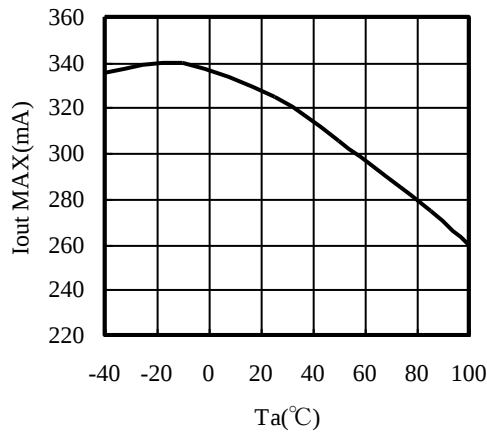
■ Supply Current

Iout=0mA



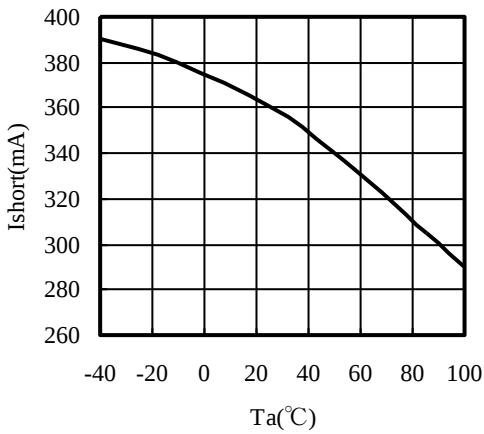
■ Maximum Output Current

$V_{out}=V_{out_TYP} \times 90\%$, $T_a=T_j$



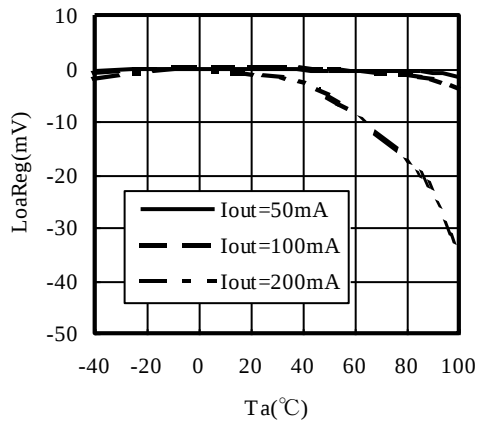
■ Short Circuit Current

$V_{out}=0V$, $T_a=T_j$

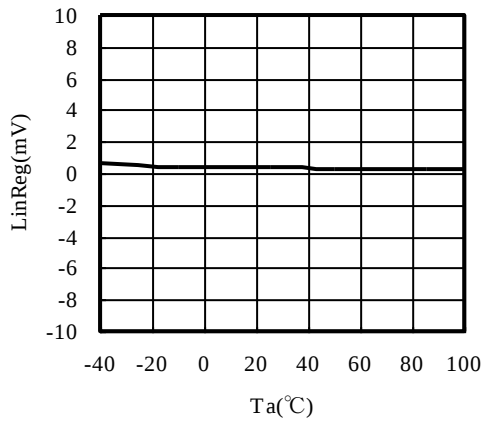


■ Load Regulation

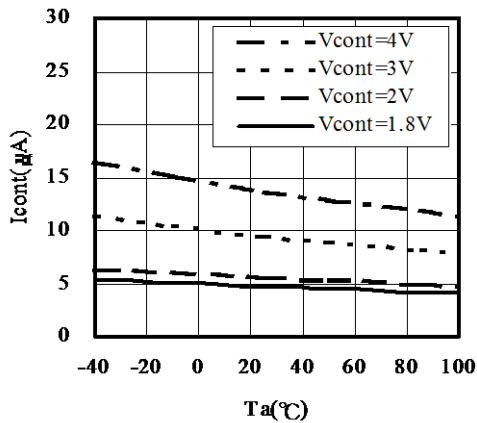
$V_{out_TYP}=3.0V$, $T_a=T_j$



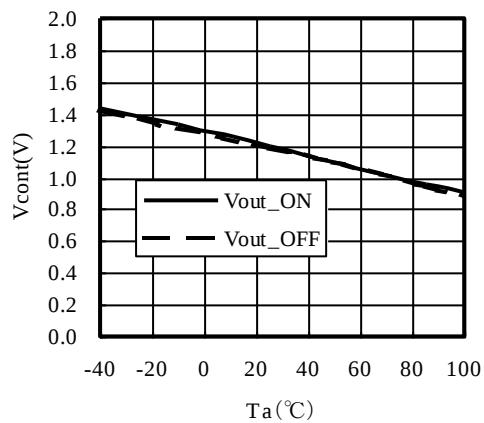
■ Line Regulation



■ Control Current



■ ON/OFF Point

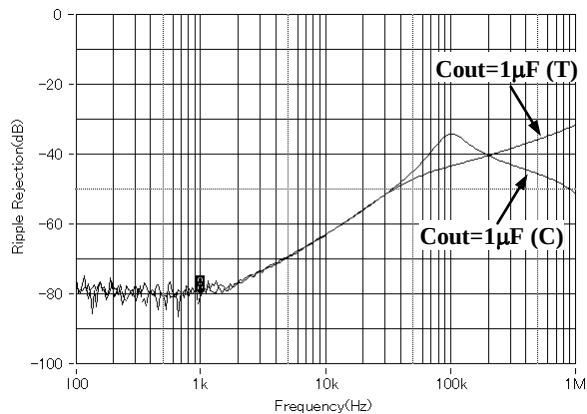


11.3 AC Characteristics

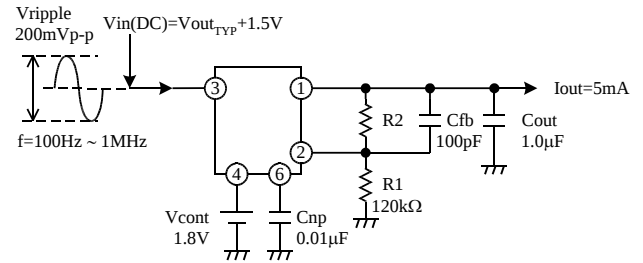
• Ripple Rejection

The ripple rejection (R.R) characteristic depends on the characteristic and the capacitance of the capacitor connected at the output side. Also it depends on the output voltage. The R.R characteristic at 50kHz or more varies greatly with the capacitor on the output side and PCB pattern. If necessary, please check stability during operation.

■ Cout=1.0μF: Ceramic (C), Tantalum (T)

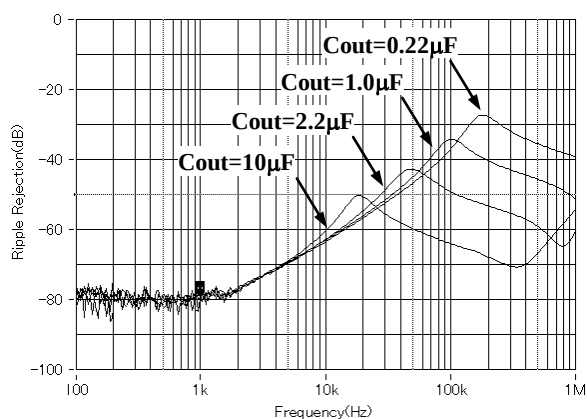


■ Test conditions

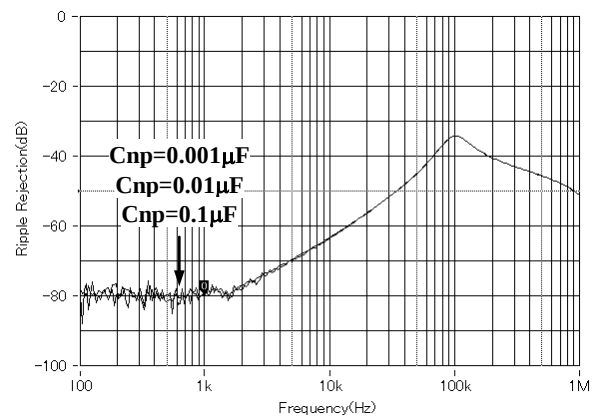


$V_{out(TYP)}=3.0V$: $R2=163.5k\Omega$

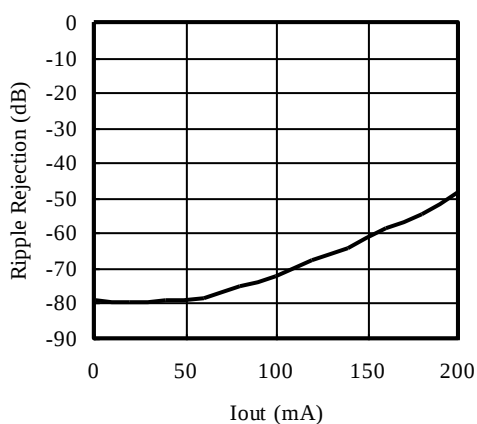
■ Cout=0.22μF, 1.0μF, 2.2μF, 10μF: Ceramic



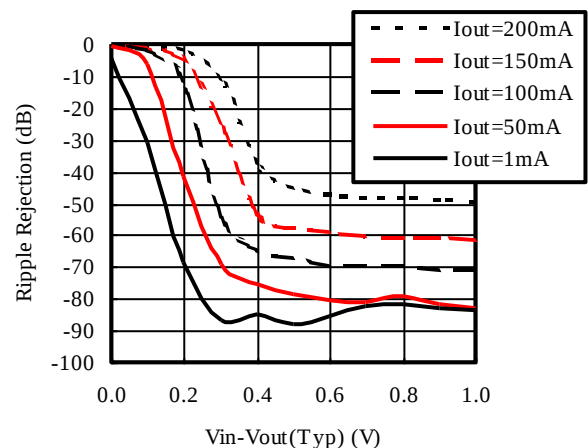
■ Cnp=0.001μF, 0.01μF, 0.1μF



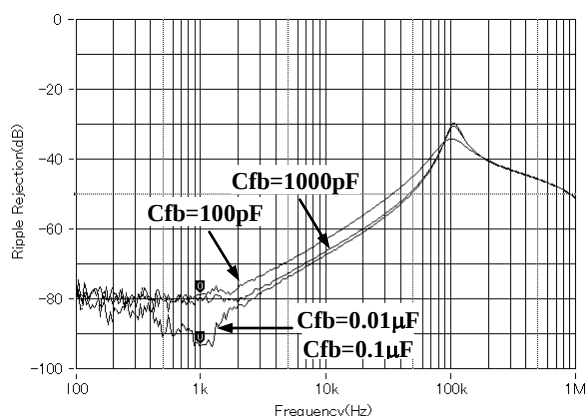
■ R.R vs. Iout: Frequency=1kHz



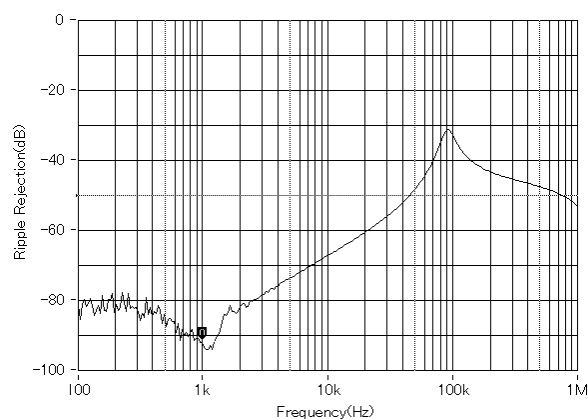
■ R.R vs. Low Vin: Frequency=1kHz



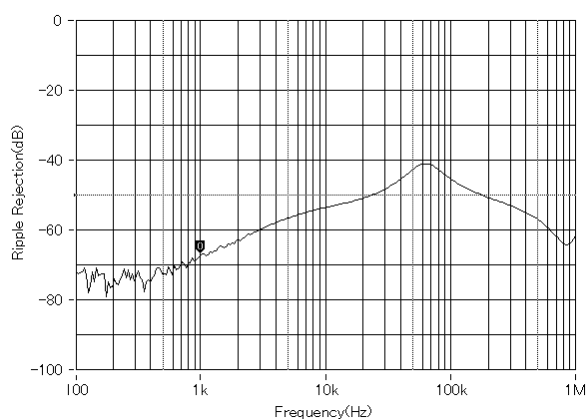
■ Cfb = 100pF, 1000pF, 0.01μF, 0.1μF
Vout_TYP=1.3V



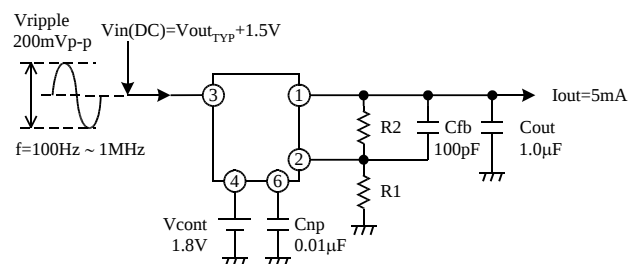
■ Vout_TYP=1.3V



■ Vout_TYP=8.0V

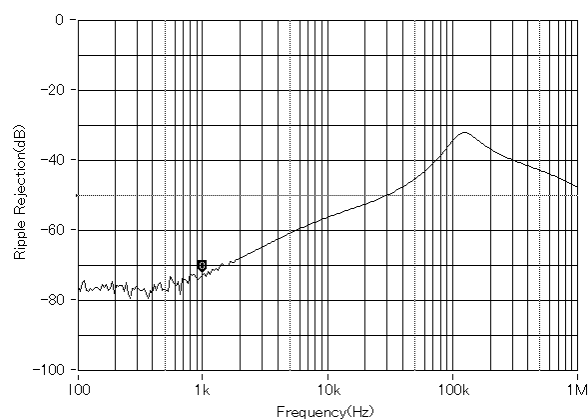


■ Test conditions

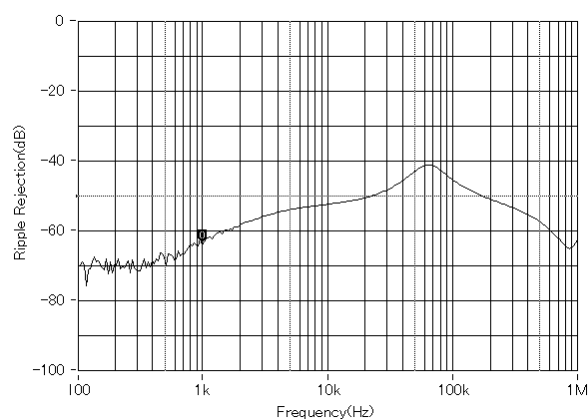


Vout_TYP = 1.3V : R1=120kΩ, R2=2.8kΩ
 3.0V : R1=120kΩ, R2=163.5kΩ
 5.0V : R1=120kΩ, R2=352kΩ
 8.0V : R1=75kΩ, R2=397kΩ
 13.0V : R1=51kΩ, R2=470kΩ

■ Vout_TYP=5.0V

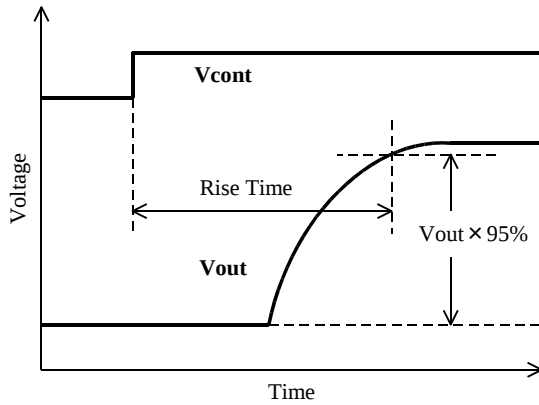


■ Vout_TYP=13V

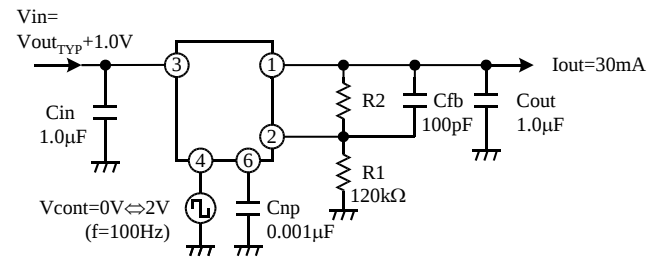


11.4 ON / OFF Transient

The rise time of the regulator depends on C_{out} and C_{np} . The fall time depends on C_{out} .

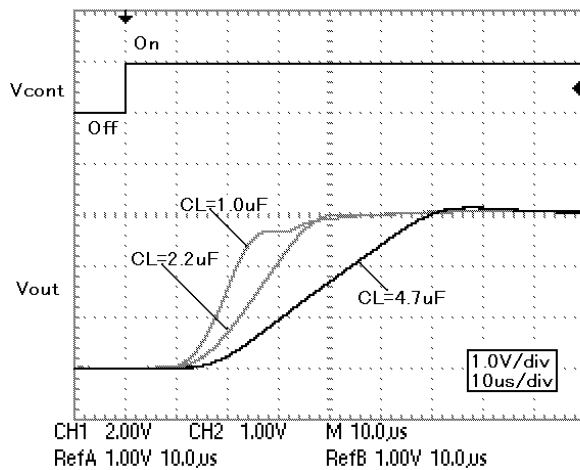


■ Test conditions

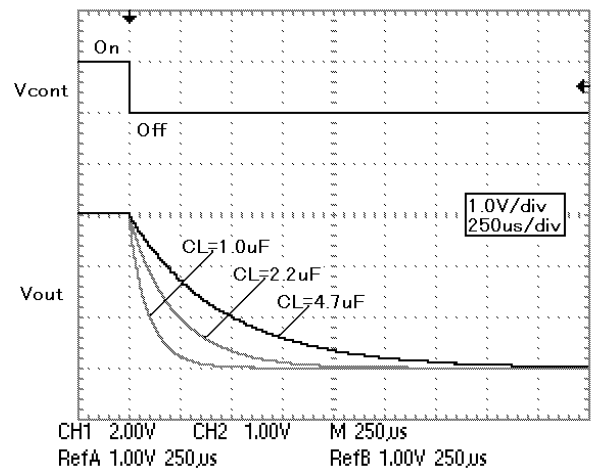


$V_{out_TYP}=3.0V$: $R2=163.5k\Omega$

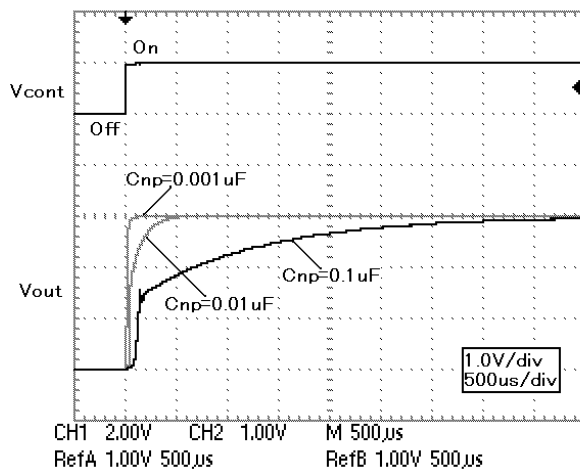
■ $C_{out}=1.0\mu F, 2.2\mu F, 4.7\mu F$



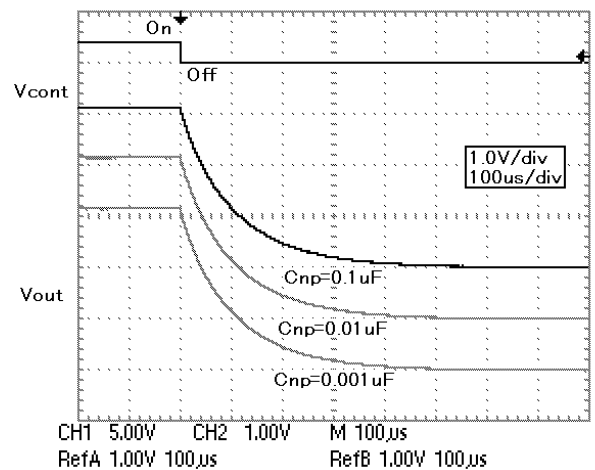
■ $C_{out}=1.0\mu F, 2.2\mu F, 4.7\mu F$



■ $C_{np}=0.001\mu F, 0.01\mu F, 0.1\mu F$



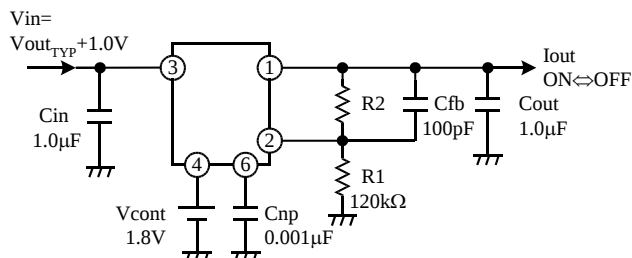
■ $C_{np}=0.001\mu F, 0.01\mu F, 0.1\mu F$



11.5 LOAD Transient

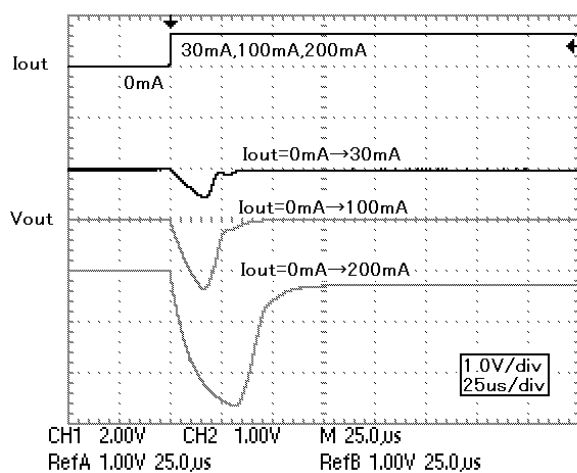
No load voltage change can be greatly improved by delivering small load current to ground. Increase the load side capacitor when the load change is fast or when there is a large current change. In addition, at no load, supplying small load current to ground can reduce the voltage change.

■ Test conditions

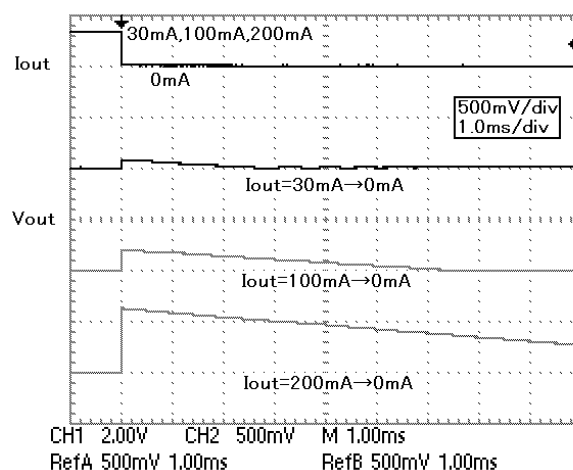


$$V_{out_TYP} = 3.0V; R2 = 163.5k\Omega$$

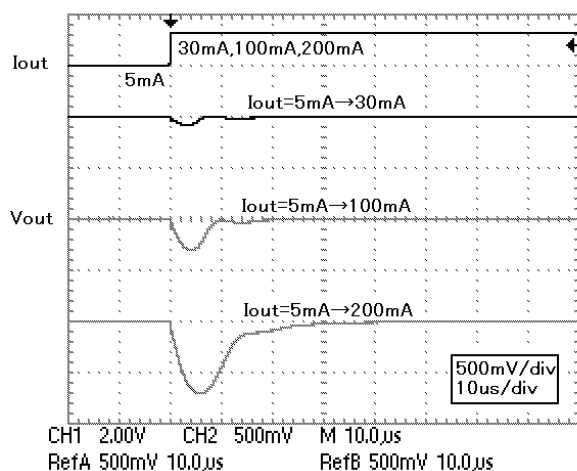
■ Iout=0→30mA, 0→100mA, 0→200mA



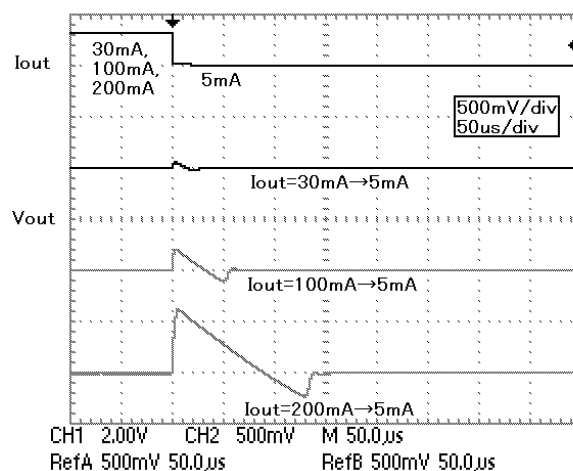
■ Iout=30→0mA, 100→0mA, 200→0mA



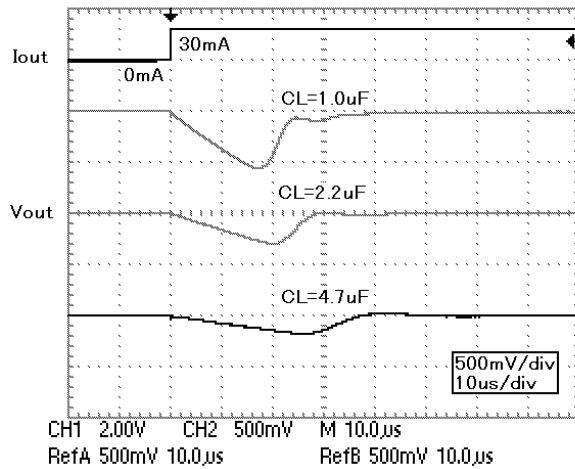
■ Iout=5→30mA, 5→100mA, 5→200mA



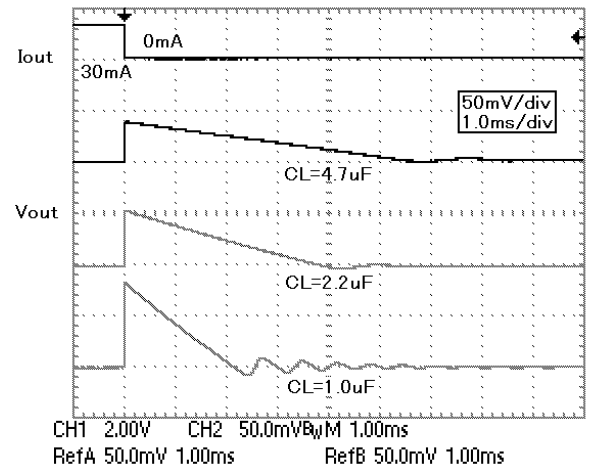
■ Iout=30→5mA, 100→5mA, 200→5mA



■ $C_{out}=1.0\mu F, 2.2\mu F, 4.7\mu F$: $I_{out}=0 \rightarrow 30mA$

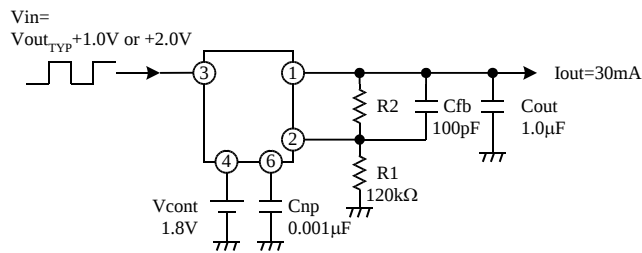


■ $C_{out}=1.0\mu F, 2.2\mu F, 4.7\mu F$: $I_{out}=30 \rightarrow 0mA$



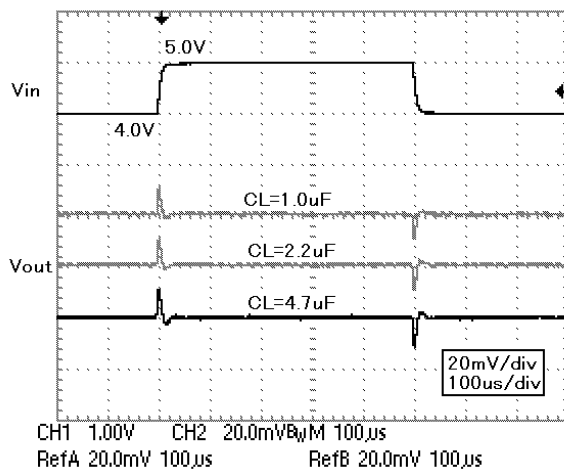
11.6 Line Transient

Test conditions

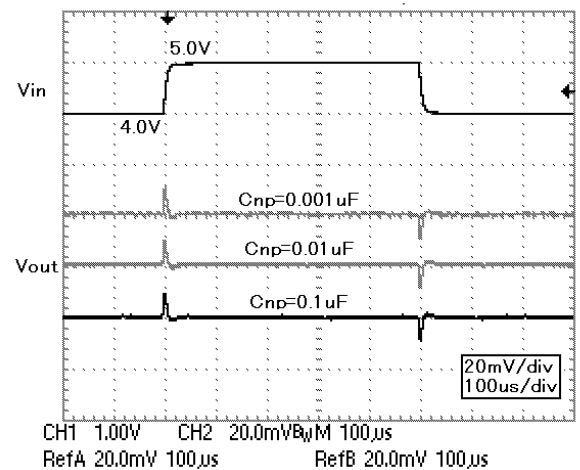


$V_{out_TYP}=3.0V$: $R2=163.5k\Omega$

■ $C_{out}=1.0\mu F, 2.2\mu F, 4.7\mu F$



■ $C_{np}=0.001\mu F, 0.01\mu F, 0.1\mu F$

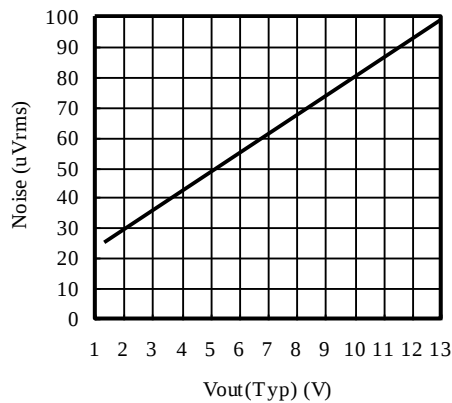


11.7 Output Noise Characteristics

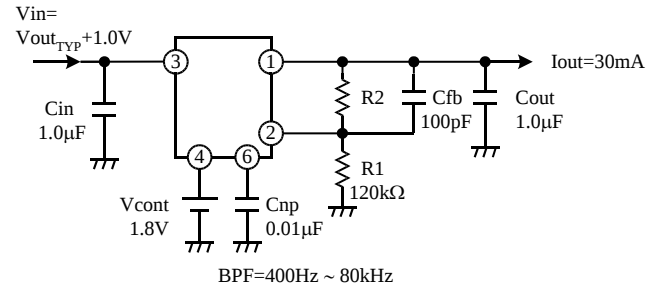
Increase C_{np} to decrease the noise. The recommended C_{np} capacitance is $0.01\mu\text{F} \sim 0.1\mu\text{F}$. The amount of noise increases with the higher output voltages.

■ V_{out} vs. Noise

$R_1=51\text{k}\Omega$, $R_2=1.2\text{k}\Omega \sim 470\text{k}\Omega$

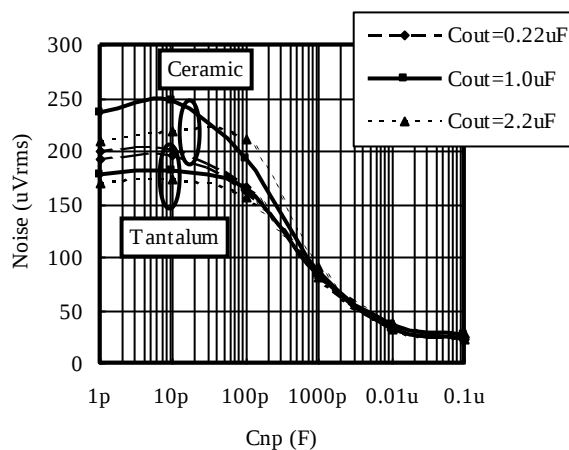


■ Test conditions

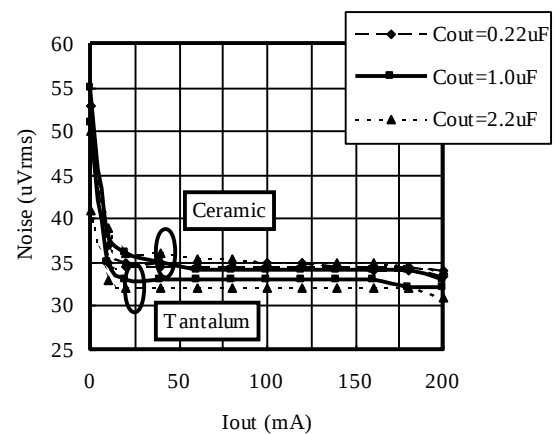


$V_{out_TYP}=3.0\text{V}$: $R_2=163.5\text{k}\Omega$

■ C_{np} vs. Noise

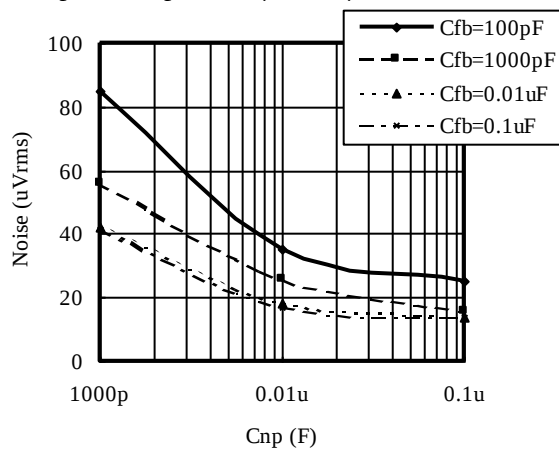


■ I_{out} vs. Noise



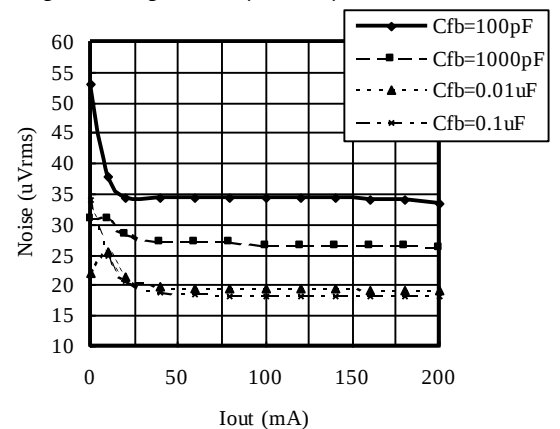
■ C_{np} vs. Noise (C_{out} : Ceramic)

$C_{fb}=100\text{pF}$, 1000pF , $0.01\mu\text{F}$, $0.1\mu\text{F}$



■ I_{out} vs. Noise (C_{out} : Ceramic)

$C_{fb}=100\text{pF}$, 1000pF , $0.01\mu\text{F}$, $0.1\mu\text{F}$



11.8 ESR Stability

Linear regulators require input and output capacitors in order to maintain the regulator's loop stability. If a $0.22\mu\text{F}$ or larger capacitor is connected to the output side, the IC provides stable operation at any voltage ($1.3\text{V} \leq V_{\text{out_TYP}} \leq 14.5\text{V}$). But due to the parts are uneven, please enlarge the capacitance as much as possible. With larger capacity, the output noise decreases more. In addition, the response to the load change, etc. can be improved. Enlarging the capacity won't damage the IC.

Moreover, increase the C_{out} capacitance when using the IC in the low current region and low voltage. Otherwise, the IC oscillates.

The equivalent series resistance (ESR) of the output capacitor must be in the stable operation area. However, it is recommended to use as large a value of capacitance as is practical. ESR values vary widely between ceramic and tantalum capacitors. However, tantalum capacitors are assumed to provide more ESR damping resistance, which provides greater circuit stability. This implies that a higher level of circuit stability can be obtained by using tantalum capacitors when compared to ceramic capacitors with similar values.

A recommended value of the application is as follows.

$$C_{\text{in}} = C_{\text{out}} \geq 0.22\mu\text{F}$$

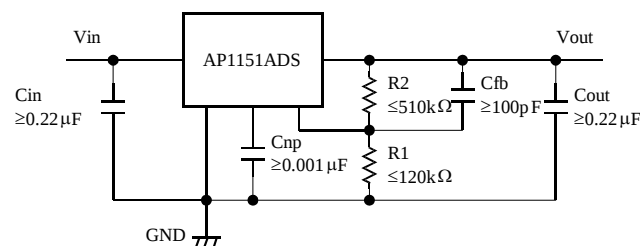
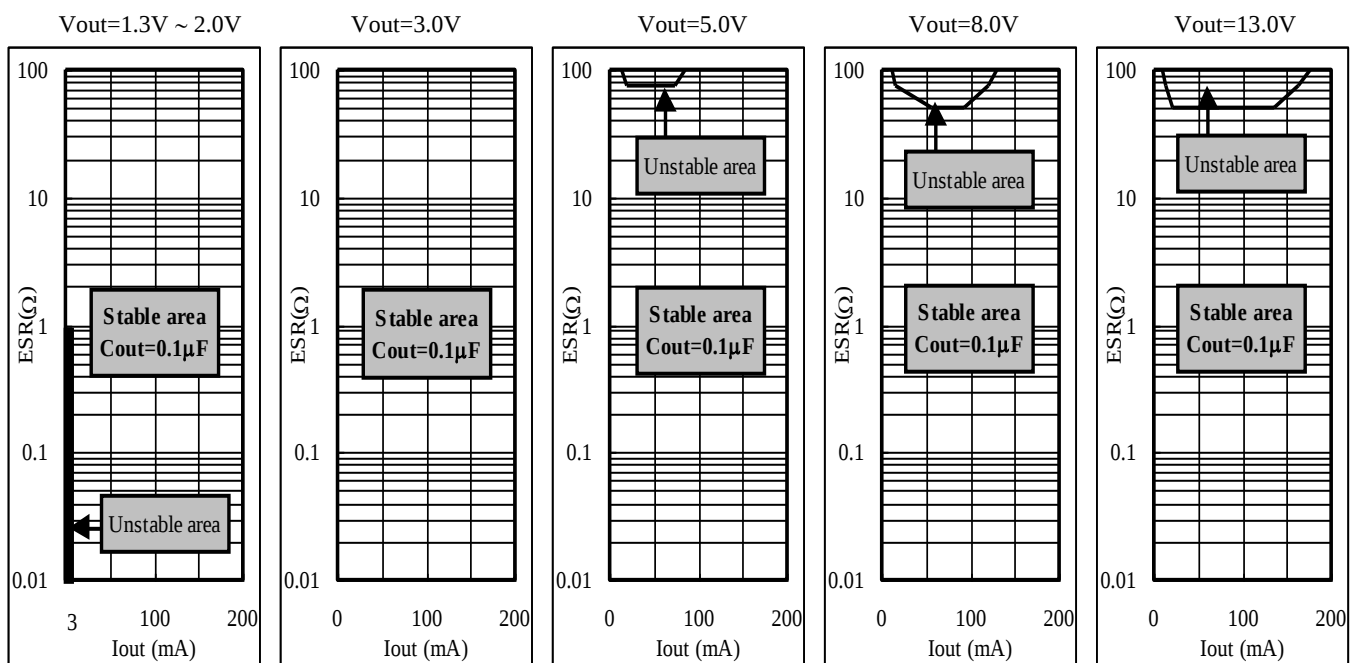


Figure 2. Recommended circuit

However, above recommended value does not satisfy some condition. Please refer to [Figure 3](#). Select the C_{out} capacitance according to the condition. If the fast load transient response is necessary, increase the C_{out} capacitance as much as possible.



All stable: $C_{\text{out}} \geq 0.22\mu\text{F}$

Figure 3. Output Voltage, Output Current vs. Stable Operation Area

Figure 3 shows stable operation area with a ceramic capacitor of 0.1μF (excluding the low voltage and the low current region). If the capacitance is not increased in the low voltage, low current region, stable operation may not be achieved. Please select the best output capacitor according to the voltage and current used. The stability of the regulator improves if a large output side capacitor is used (the stable operation area extends.) Please use as large a capacitance as is practical.

For evaluation

Kyocera: CM05B104K10AB, CM05B224K10AB, CM105B104K16A, CM105B224K16A, CM21B225K10A

Murata: GRM36B104K10, GRM42B104K10, GRM39B104K25, GRM39B224K10, GRM39B105K6.3

Generally, a ceramic capacitor has both a temperature characteristic and a voltage characteristic. Please consider both characteristics when selecting the part. The B curves are the recommend characteristics.

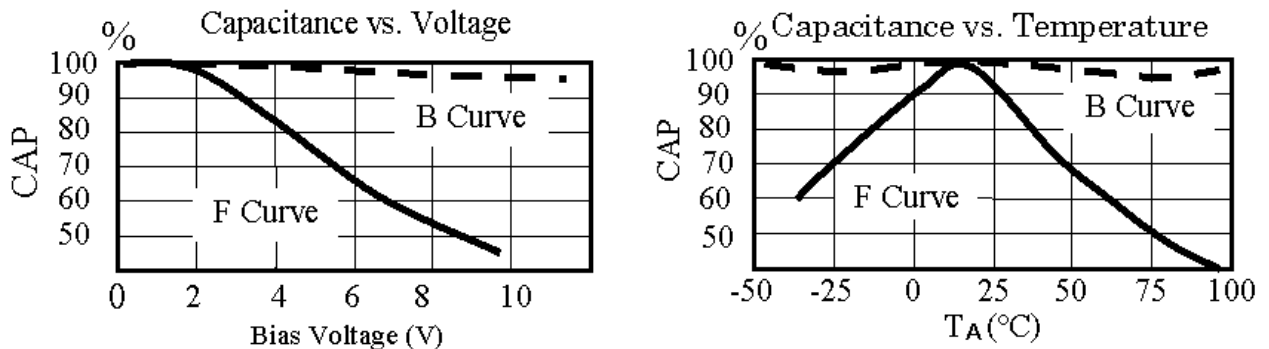


Figure 4. Ceramic Capacitance vs. Voltage, Temperature

11.9 Operating Region and Power Dissipation

The power dissipation of the device is dependent on the junction temperature. Therefore, the package dissipation is assumed to be an internal limitation. The package itself does not have enough heat radiation characteristic due to the small size. Heat runs away by mounting IC on PCB. This value changes by the material, copper pattern etc. of PCB. The overheating protection operates when there is a lot of loss inside the regulator (Ambient temperature high, heat radiation bad, etc.). The output current and the output voltage will drop when the protection circuit operates. When joint temperature (T_j) reaches the set temperature, IC stops the operation. However, operation begins at once when joint temperature (T_j) decreases.

• The thermal resistance when mounted on PCB

The chip joint temperature during operation is shown by $T_j = \theta_{JA} \times P_d + T_a$. Joint part temperature (T_j) of AP1151ADS is limited around 150°C with the overheating protection circuit. P_d is the value when the overheating protection circuit starts operation.

When you assume the ambient temperature to be 25°C,

$$150 = \theta_{JA} \times P_d (W) + 25$$

$$\theta_{JA} \times P_d = 125$$

$$\theta_{JA} = 125 / P_d (\text{°C/W})$$

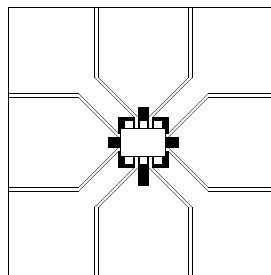


Figure 5. Example of mounting substrate

PCB Material: Two-layer glass epoxy substrate (x=30mm, y=30mm, t=1.0mm, Copper pattern thickness 35μm)

• Method of obtaining Pd easily

Connect output terminal to GND (short circuited), and measure the input current by increasing the input voltage gradually up to 10V. The input current will reach the maximum output current, but will decrease soon according to the chip temperature rising, and will finally enter the state of thermal equilibrium (natural air cooling). The input current and the input voltage of this state will be used to calculate the Pd. When the device is mounted, mostly achieve 500mW or more.

$$Pd(mW) \cong V_{in} (V) \times I_{in} (mA)$$

The maximum output current at the highest operating temperature will be $I_{out} \cong DPd \div (V_{inmax} - V_{out})$. Please use the device at low temperature with better radiation. The lower temperature provides better quality.

In the case that the power, $V_{in} \times I_{short}$ (Short Circuit Current), becomes more than the maximum rating of its power dissipation in a moment, there is a possibility that the IC is destroyed before internal thermal protection works.

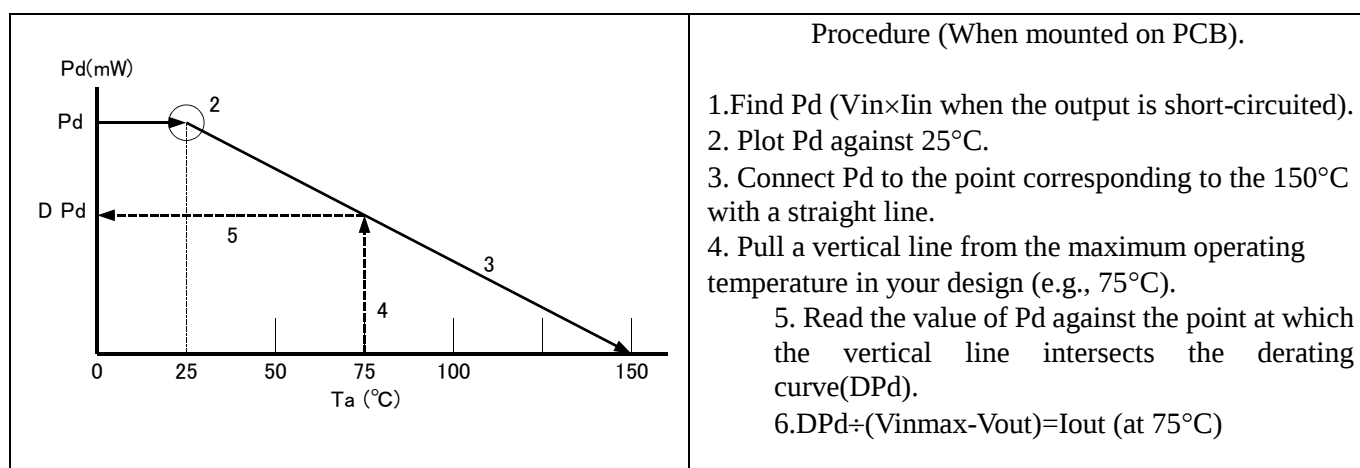


Figure 6. Obtaining Pd

11.10 ON/OFF Control

It is recommended to turn the regulator off when the circuit following the regulator is not operating. A design with small electric power loss can be implemented. Because the control current is small, it is possible to control it directly by CMOS logic.

Table 1.

Control Terminal Voltage (Vcont)	ON/OFF State
$V_{cont} > 1.8V$	ON
$V_{cont} < 0.35V$	OFF

11.11 Noise Bypass

The noise characteristics depend on the capacitance on the Np terminal. A standard value is $C_{np} = 0.001\mu F$. Increase C_{np} in a design with important output noise requirements. The IC will not be damaged even the capacitor value is increased. The on/off switching speed changes depending on the Np terminal capacitance. The switching speed slows when the capacitance is large.

11.12 The notes of the evaluation when output terminal is short-circuit to GND

By the resonance phenomenon by Cout (C ingredient) and the short circuit line (L ingredient), which are attached to an output terminal, an output terminal changes with minus potential. In order that Parasitism Tr arises within Bip IC, and a latch rise phenomenon may occur within IC when the worst if it goes into an output terminal's minus side, it results in damage by fire (white smoke) and breakage of a package. ($f_0 = 1 / 2\pi\sqrt{L C}$)

The above-mentioned resonance phenomenon appears notably in a ceramic capacitor with the small ESR value, etc. A resonance phenomenon can be reduced by connecting resistance (around 2ohms or more) in series with a short circuit line. Thereby, the latch rise phenomenon within IC can be prevented.

Generally, when using tantalum or large electrolysis capacitor, the influence of resonance phenomenon can be reduced due to the large ESR (2ohms or more)

12. Definition of term

■ Relating Characteristic

Each characteristic will be measured in a short period not to be influenced by joint temperature (T_j).

- **Output voltage (V_{out})**

The output voltage is specified with $V_{in} = V_{out_TYP} + 1V$ and $I_{out} = 5mA$

- **Output current (I_{out})**

Output current, which can be used continuously (It is the range where overheating protection of the IC does not operate.)

- **Maximum output current (I_{out_MAX})**

The rated output current is specified under the condition where the output voltage drops 90% by increasing the output current, compared to the value specified at $V_{in} = V_{out_TYP} + 1V$.

- **Dropout voltage (V_{drop})**

It is an I/O voltage difference when the circuit stops the stable operation by decreasing the input voltage.

It is measured when the output voltage drops 100mV from its nominal value by decreasing the input voltage gradually.

- **Line Regulation ($LinReg$)**

It is the fluctuations of the output voltage value when the input voltage is changed.

- **Load Regulation ($LoaReg$)**

It is the fluctuations of the output voltage value when the input voltage is assumed to be $V_{out_TYP} + 1V$, and the load current is changed.

- **Ripple Rejection ($R.R$)**

Ripple rejection is the ability of the regulator to attenuate the ripple content of the input voltage at the output.

It is measured with the condition of $V_{in} = V_{out} + 1.5V$. Ripple rejection is the ratio of the ripple content between the output vs. input and is expressed in dB.

- **Standby current ($I_{standby}$)**

It is an input current, which flows to the control terminal, when the IC is turned off.

■ Relating Protection Circuit

- **Over Current Protection**

It is a function to protect the IC by limiting the output current when excessive current flows to IC, such as the output is connected to GND, etc.

- **Thermal Protection**

It protects the IC not to exceed the permissible power consumption of the package in case of large power loss inside the regulator.

The output is turned off when the chip reaches around 150°C, but it turns on again when the temperature of the chip decreases.

- **Reverse Voltage Protection**

Reverse voltage protection prevents damage due to the output voltage being higher than the input voltage. This fault condition can occur when the output capacitor remains charged and the input is reduced to zero, or when an external voltage higher than the input voltage is applied to the output side. Generally, a LDO regulator has a diode in the input direction from an output. If an input falls from an output in an input-GND short circuit etc. and this diode turns on, current will flow for an input terminal from an output terminal. In the case of excessive current, IC may break. In order to prevent this, it is necessary to connect an Schottky Diode etc. outside. This product is equipped with reverse bias over-current prevention, and excessive current does not flow in to IC. Therefore, no need to connect diode outside.

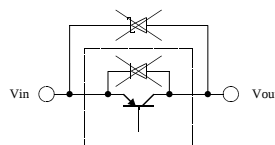


Figure 7.

13. Recommended External Circuits

■ External Circuit

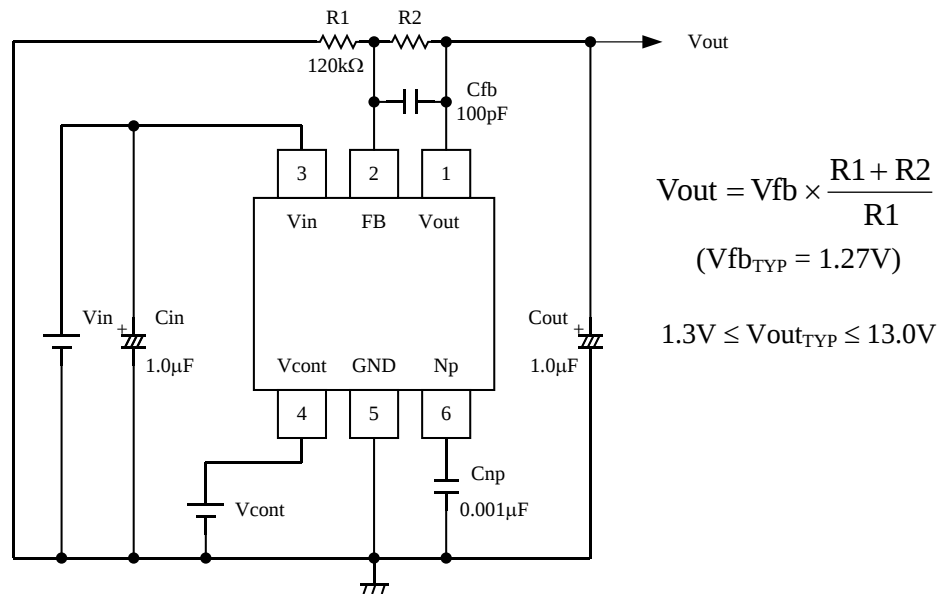
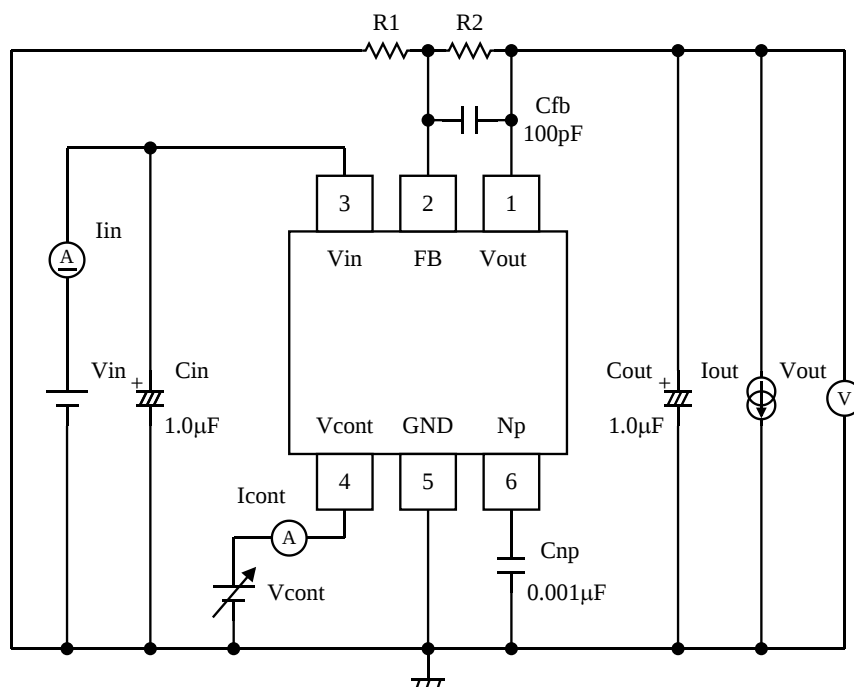


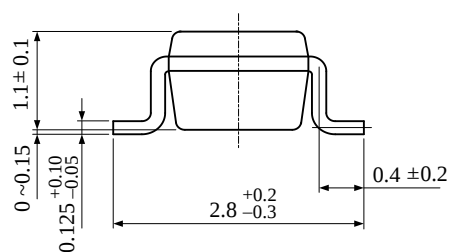
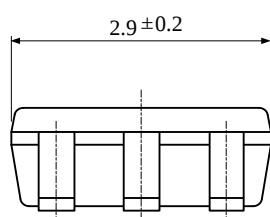
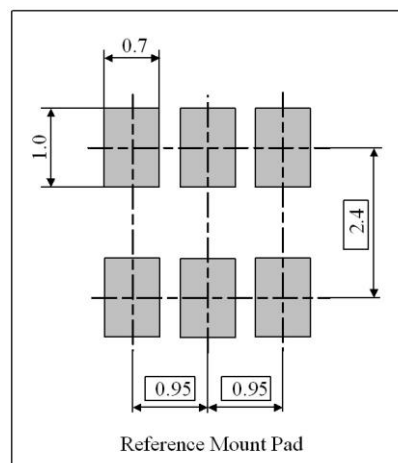
Figure 8. External Circuit

Note 6. In the actual application, either ceramic or tantalum capacitor can be used for Cin and Cout. Please set feedback resistor R1, R2 current larger than 10μA. The current is fixed with $V_{fb}/R1$. Please fix R2 value smaller than 510kΩ. In case of high output voltage, please adjust R1 value in order to make R2 value smaller than 510kΩ. Recommended capacitor value for Cfb: Cfb=100pF

■ Test Circuit

Figure 9. Test Circuit (R1=51kΩ, R2=68kΩ (Vout_{TYP}=3.0V))

■ Outline Dimensions



15. Revise History

Date (YY/MM/DD)	Revision	Page	Contents
15/01/21	00	-	First edition

IMPORTANT NOTICE

0. Asahi Kasei Microdevices Corporation (“AKM”) reserves the right to make changes to the information contained in this document without notice. When you consider any use or application of AKM product stipulated in this document (“Product”), please make inquiries the sales office of AKM or authorized distributors as to current status of the Products.
1. All information included in this document are provided only to illustrate the operation and application examples of AKM Products. AKM neither makes warranties or representations with respect to the accuracy or completeness of the information contained in this document nor grants any license to any intellectual property rights or any other rights of AKM or any third party with respect to the information in this document. You are fully responsible for use of such information contained in this document in your product design or applications. AKM ASSUMES NO LIABILITY FOR ANY LOSSES INCURRED BY YOU OR THIRD PARTIES ARISING FROM THE USE OF SUCH INFORMATION IN YOUR PRODUCT DESIGN OR APPLICATIONS.
2. The Product is neither intended nor warranted for use in equipment or systems that require extraordinarily high levels of quality and/or reliability and/or a malfunction or failure of which may cause loss of human life, bodily injury, serious property damage or serious public impact, including but not limited to, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. Do not use Product for the above use unless specifically agreed by AKM in writing.
3. Though AKM works continually to improve the Product’s quality and reliability, you are responsible for complying with safety standards and for providing adequate designs and safeguards for your hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of the Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption.
4. Do not use or otherwise make available the Product or related technology or any information contained in this document for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). When exporting the Products or related technology or any information contained in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations. The Products and related technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations.
5. Please contact AKM sales representative for details as to environmental matters such as the RoHS compatibility of the Product. Please use the Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. AKM assumes no liability for damages or losses occurring as a result of noncompliance with applicable laws and regulations.
6. Resale of the Product with provisions different from the statement and/or technical features set forth in this document shall immediately void any warranty granted by AKM for the Product and shall not create or extend in any manner whatsoever, any liability of AKM.
7. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of AKM.